IDEA Tracker Resolution Studies

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IDEA Tracking System Performance – First Results



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More realistic(?) resolutions

- Red: Berlin
- ◆ Black: New
 Inspired by ILD/SiD/CLIC:
 ◇ VTX: 5 -> 3 µm
 ◇ Outer Si: 10 -> 7 µm
 Franco Grancagnolo:
 - * DC: σ_{Rφ} = 75 -> 80 µm
- Changes basically only affects vertex resolution
 Except at highest p_T
- Use black curve as new reference



Drop VTX layers 4-7



Compare "ALICE VTX" to CLIC VTX

 ALICE: 3 single layers Azimuthal Angle Resolution .vs. Pt Momentum Resolution .vs. Pt □ 0.3% Xo Azimuthal Angle Resolution (mrad) 0 1 \square 3 μ m resolution Momentum Resolution (%) 0 1 1 phi & z res [um] layerEff Name r [cm] X0 ALICE_vtx1 1.70 0.0030 1.00 3 ALICE_vtx2 2.30 0.0030 3 3 1.00 3 4. ALICE_vtx3 0.0030 1.00 3.10 CLIC: 3 double layers □ 3 * 2* 0.2% Xo 10⁻² \square 3 µm, 6 µm, 4 µm resolutions 10 100 10 100 Transverse Momentum (GeV/c) Transverse Momentum (GeV/c) Name r [cm] X0 phi & z res [um] layerEff R Pointing Resolution .vs. Pt Z Pointing Resolution .vs. Pt 2. CLIC_vtx11 1.70 0.0020 1.00 3 3 0.0020 6 1.00 CLIC vtx12 1.90 6 40 40 0.0020 4 1.00 CLIC_vtx21 3.70 5. CLIC_vtx22 3.90 0.0020 4 1.00 35 35 0.0020 1.00 CLIC_vtx31 5.70 4 7. CLIC_vtx32 5.90 0.0020 1.00 R-¢ Pointing Resolution (µm) Z Pointing Resolution (µm) 30 30 25 25 CLIC-like design: 20 20 15 15 Slightly better vertex resolution 10 10 □ Probably due to larger r-spacing 5 5 Trivial modification 0 0 10 100 10 1 100 Transverse Momentum (GeV/c) Transverse Momentum (GeV/c)

Decrease Drift Chamber inner radius: 35 -> 20 cm

• Keep cell size the same:

□ 112 -> 122 cells

- Multiply all DC material by factor 180./165.
- Very minor improvement in momentum resolution
- Here and on following slides, use CLIC-like VTX



Reduce Drift Chamber Cell Size: 1.47 -> 1.0 cm

- Keep the same resolution of $\sigma_{r\phi}$ = 80 µm per point
- Black: 1.47 cm cell size
- Red: 1.00 cm cell size
- Looks like a good idea, however, here no account is made of additional material from wires...

See next page



Reduce Drift Chamber Cell Size: Wire material



Material Study: Double Material

Black: Reference

Beam pipe: 0.48% of Xo
 VTX: CLIC-like

- ♦ 6 * 0.2% of Xo
- DC: 20-180cm; 1 cm cells
 - ✤ InWall: 0.08% of Xo
 - ✤ Wire+gas: 0.36% of Xo
 - OutWall: 1.3% of Xo
- ם Outer Si: 201 cm, 7 μm
- Red: Double BP material

 Minimal influence on σ_p
- Blue: Double VTX material
 Minimal influence on σ_p
- Green: Double DC material
 Minimal influence on impact parameter resolution



Point Resolution Study

- Black: Reference
- Blue: 1 μm point VTX resolution everywhere
- Green: 70 μm DC rφ resolution (was 80 μm)
- \bullet Red: 5 μm Outer Si point resolution (was 7 $\mu m)$

E.g. From two layers



Something completely different: TOF

- Ultrafast silicon detectors are approaching 20 ps resolution, possibly going to 10 ps and below.
- Use outer layer of Si tracker for TOF measurement?
- 10 ps gives pion/kaon separation up to 7-8 GeV
- Worthwhile pursuing? Particularly for all-silicon detector which does not have dE/dx measurent like the Cluster Counting Drift Chamber



Summary

- First studies of IDEA tracker resolution presented
- Some conclusions:
 - □ Limit Si sensors only to dedicated vertex detector (r<60 mm)
 - Aim to have VTX very light to mimimise multiple scattering
 - However, cooling...
 - Beam pipe + VTX material plus VTX point resolution important for impact parameter resolution
 - \square Drift Chamber material important for momentum resolution for p_T $\stackrel{\scriptstyle <}{\scriptstyle \sim}$ 20 GeV
 - Multiple scattering from wires inside DC
 - Probably not well described by my tool: 112 discrete layers vs. few wires hit
 - Point resolution of all detector elements important for higher momenta
- Si tracker based TOF measurement